PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chen-Yong Cher	12/22/2010
Wilfried E. Haensch	12/21/2010
Eren Kursun	12/23/2010
David R. Motschman	12/22/2010

RECEIVING PARTY DATA

Name:	INTERNATIONAL BUSINESS MACHINES CORPORATION
Street Address:	NEW ORCHARD ROAD
City:	ARMONK
State/Country:	NEW YORK
Postal Code:	10504

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12984096

CORRESPONDENCE DATA

Fax Number: (972)733-1575

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Address Line 2: 17330 PRESTON ROAD, SUITE 100B

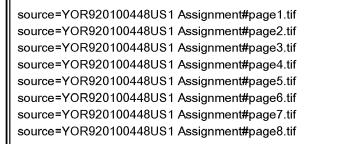
Address Line 4: DALLAS, TEXAS 75252

ATTORNEY DOCKET NUMBER:	YOR920100448US1
NAME OF SUBMITTER:	Stephen J. Walder, Jr.

Total Attachments: 8

PATENT REEL: 025579 FRAME: 0621 \$40.00 12984

501396125



ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") in:

Title of the Invention:

THERMAL CYCLING AND GRADIENT MANAGEMENT IN THREE-DIMENSIONAL STACKED ARCHITECTURES

and further identified by the IBM Docket Number provided above in the header of this Assignment, for which an application for a United States Patent was executed concurrently herewith or was filed having:

Application No: 12/984, 096 (insert series code/serial number here if/when available)

Whereas, international Business Machines Corporation, a corporation of New York having a place of business at Armonk, New York (herein referred to as "IBM"), desires to acquire, and each undersigned inventor desires to grant to IBM, the entire worldwide right, title, and interest in and to the invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") bereby sells, assigns, and otherwise transfers to IBM (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM. its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

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[Inventor Signature Page(s) Follows]

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	<u>Exe</u>	cuted by Inventor I
Signature: _	Chen-Yong Cher	Date: 12/22/2010
	<u>Exec</u>	sated by Inventor 2
Signature:	Wilfried E. Hacasch	Date:
	Exec	uted by Inventor 3
Signature:	Eren Kursun	Date:
	Ехос	uted by Inventor 4
Signature:	David R. Motschman	Date:

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[Inventor Signature Page(s) Follows]

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	Executed by Inventor 1
Signature:	Chen-Yong Cher
****	Executed by Inventor 2
Signature: _	Wilfried E. Haensch Date: 12-21-2070
,	Executed by Inventor 3
Signature: _	Eren Kursun
	Executed by Inventor 4
	E/ALAMICU DY SHYLHOUS Y
Signature: _	David P. Motschman

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	Executed b	y Inventor 1	
Signature: _	Chen-Yong Cher	Date:	
	Executed b	y Inventor 2	
Signature: _	Wilfried E. Haensch	Date:	
	Executed b	y Inventor,3	
Signature: _	Eren Kursua	Date: 12/23/10	
	Executed by	y Inventor 4	
	David R. Motschman	Date:	

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***************************************	Executed by Inventor 1
Sígnaturc: _	Date: Date:
	Executed by Inventor 2
Signature: _	Wilfried E. Haensch
	Executed by Inventor 3
Signature: _	Eren Kursun
	Executed by Inventor 4
Signature: _	Date: 12/22/2010

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